

SEMI GLOBAL UPDATE

September 8, 2026

What's New at SEMI



Market Intelligence

Global Semiconductor Equipment Billings Increased 23% Year-Over-Year in Q2 2026, SEMI Reports

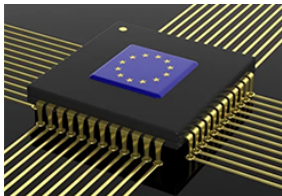
“The second consecutive quarter of record semiconductor equipment billings reflects the industry's ...,” said Ajit Manocha, SEMI President and CEO.



Semiconductor Innovation

SEMI and Silicon Catalyst Aim to Accelerate Global Semiconductor Innovation with Strategic Partnership

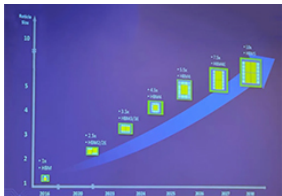
“By partnering with Silicon Catalyst, we are creating a powerful global platform that connects ...,” said Ajit Manocha, President and CEO of SEMI.



Public Policy and Advocacy

SEMI Calls on the Chips Act 2.0 to Strengthen Semiconductor Competitiveness and Resilience

“The Chips Act 2.0 provides an important opportunity to build on Europe's existing strengths,” said Laith Altimime, President of SEMI Europe.



SEMI-Related

Semiconductor Engineering: Multi-Die Assemblies Dominate at 2nm and Below

Chips are getting bigger and more modular and capable as new innovations mix with existing processes and long-researched projects go mainstream.

Upcoming Events/Webinars

- | | |
|-----------|---|
| Sep 15 | SEMI Northeast Professional Development Seminar (PDS)
Albany, New York Eastern Daylight Time |
| Sep 15-16 | Overview of Semiconductor Manufacturing
Virtual Central European Time |
| Sep 23 | SEMI Austin Golf Classic
Hutto, Texas Central Daylight Time |

[More events](#)

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